

- () Preliminary Specifications(V) Final Specifications

Module	14.0"(13.97") HD 16:9 Color TFT-LCD with LED Backlight design
Model Name	B140XTT01.1 (HW:1A)
Note (🗭)	e-TP Display (LCM: B140XTN06.1 + TP: I140FGT01.1)

Customer	Date	Approve
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Note: This Specification without notice.	is subject to change	NBE AU

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Record of Revision

Ve	Version and Date Page		Old description	New Description	Remark
0.0	2013/04/10	All	First Edition for Customer		
1.0	2013/06/05	06/05 5 2.1 General Specification		Add Weight & Physical Size & Total solution Length	
		7	2.2 General Touch Specification	TP F/W version update	
		13	3. Functional Block Diagram	Add Functional Block Diagram	
		27	8. Mechanical Characteristics	Add 2D drawing	
			8.1 Total Solution Outline Dimension		
		29	10. Appendix: EDID Description	Add EDID	
1.1	2013/08/07	5	2.1 General Specification	Modify Thickness of Total solution	
		7	2.2 General Touch Specification	Update TP Final F/W version	
		28	8.1 Total Solution Outline Dimension	Update 2D drawing	

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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 10) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 11)Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 12) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostatic breakdown.

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2. General Description

B140XTT01.1 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 HD, 1366(H) x768(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are eDP (Embedded DisplayPort) interface compatible.

B140XTT01.1 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 $^{\circ}\mathrm{C}$ condition:

Items	Unit	Specifications				
Screen Diagonal	[mm]	354.95				
Active Area	[mm]	309.4 x 173.95				
Pixels H x V		1366x3(RC	3B) x 768			
Pixel Pitch	[mm]	0.2265 x 0	.2265			
Pixel Format		R.G.B. Vertical Stripe				
Display Mode		A Normally White				
White Luminance (ILED=23mA) (Note: ILED is LED current)	[cd/m ²]	200 typ. (5 points average) 170 min. (5 points average)				
Luminance Uniformity		1.25 max. (5 points)				
Contrast Ratio		500 typ				
Response Time	[ms]	8 typ / 16 N	Лах			
Nominal Input Voltage VDD	[Volt]	+3.3 typ.				
Power Consumption	[Watt]	3.4 max (Include Logic and Blu power)				
Weight	[Grams]	285 g max (Panel Only)g 406 g max (Total Solution) ¹				
Physical Size	[mm]		Min.	Тур.	Max.	
		Length	329.35	329.6	329.85	
		Width	204.60	205.10	205.60	

¹ Total solution max weight includes touch sensor FPCA and OGS.



		Thickness	-	-	3.0 (Panel Side) 3.0 (PCBA Side)	
			Min.	Тур.	Max.	
		Length	329.33	329.58	329.83	
Total solution [Note: OGS Touch module]	[mm]	Width	204.60	205.10	205.60 (206.94 with FPCA)	
		Thickness	-	-	3.95 (Panel Side) 3.8 (PCBA Side) 5.3 (Total)	
Electrical Interface		1 Lane eDP 1.2				
Glass Thickness	[mm]	0.4				
Surface Treatment		Glare, Hardness 3H				
Support Color		262K colors (RGB 6-bit)				
Temperature Range Operating Storage (Non-Operating)	[°C]	-20 to +60 -20 to +60				
RoHS Compliance		RoHS Com	pliance			



2.2 General Touch Specification

Item	Spec	Unit
Type of Touch Sensor	Projective Capacitive (OGS)	
Panel Size	14.0'	
Outline Dimension	321.10 X 185.9 typ	mm
Total Thickness	0.7 typ	mm
Total Weight	117 max	g
TP View Area	310.40 X 174.95 typ	mm
TP Active Area	311.40 X 175.95 typ	mm
Interface	USB & I2C	
Report Rate	Follow win8 – 100Hz	Hz
Multi-Touch Point	10 points	
Input method	Finger	
Touch panel sensor IC	EETI (EXC7900)	
Channel	65 x 37	
Distance between 2 point	Follow win8 – 12	mm
Surface hardness	7	Н
TP F/W version	0627Y13 (Version : 00)	
BM ink	PANTONE BLACK C	
	Active Mode: 264	mW
TP Power Consumption	Idle Mode: 75	mW
	Sleep Mode:6.6	mW

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2.3 Optical Characteristics

The optical characteristics are measured under stable conditions at 25°C (Room Temperature) :

Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Note
White Luminance ILED=23mA (Base Panel Only)			5 points average	170	200	-	cd/m2	1, 4, 5.
V:		θR θL	Horizontal (Right) CR = 10 (Left)	40 40	45 45	-	degree	4, 9
Viewing A	igie	ψH ψL	Vertical (Upper) CR = 10 (Lower)	10 30	15 35	-		4, 9
Luminan Uniformi		δ5Ρ	5 Points	-	-	1.25		1, 3, 4
Luminance Uniformity		δ13Ρ	13 Points	-	-	1.6		2, 3, 4
Contrast Ratio		CR		400	500	-		4, 6
Cross talk		%				4		4, 7
Response Time		TRT	Rising + Falling	-	8	16		
	Red	Rx		0.550	0.580	0.610		
		Ry		0.305	0.335	0.365		
Color /	Green	Gx		0.300	0.330	0.360		
Chromaticity		Gy		0.535	0.565	0.595	_	
Coodinates	Blue	Вх	CIE 1931	0.125	0.155	0.185	_	4
	Diue	Ву		0.110	0.140	0.170	-	
	\A/Ic!+ -	Wx		0.283	0.313	0.343	-	
	White	Wy		0.299	0.329	0.359		
NTSC		%		-	45	_		

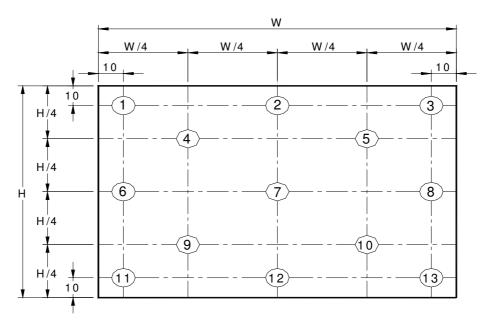
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Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

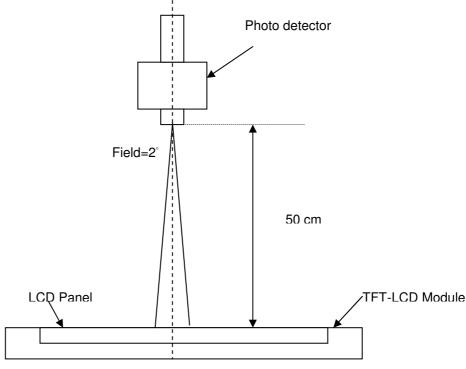
6		Maximum Brightness of five points
δ _{W5}	=	Minimum Brightness of five points
2		Maximum Brightness of thirteen points
δ w13	= '	Minimum Brightness of thirteen points

Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting



Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Center of the screen

Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points \cdot $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Note 7: Definition of Cross Talk (CT)

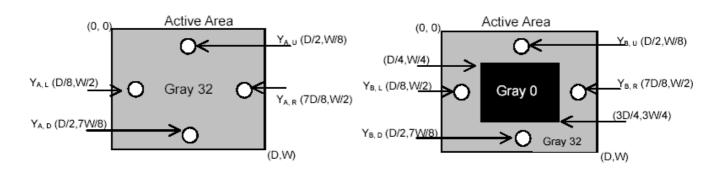
$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

Where

Y_A = Luminance of measured location without gray level 0 pattern (cd/m₂)

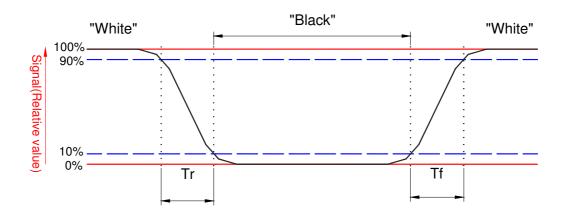
Y_B = Luminance of measured location with gray level 0 pattern (cd/m₂)





Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.



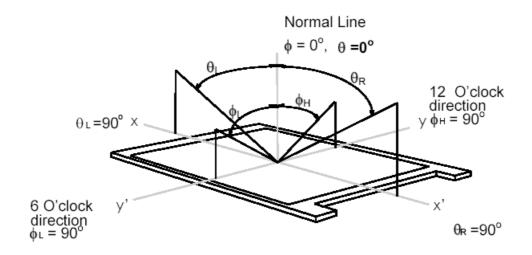
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Note 9. Definition of viewing angle

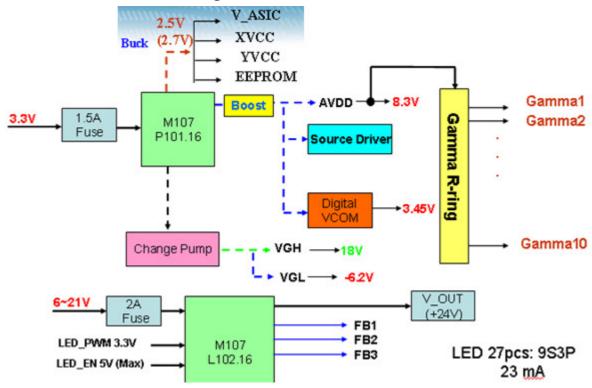
Viewing angle is the measurement of contrast ratio \geq 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.



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3. Functional Block Diagram



4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Touch Sensor

Item	Symbol	Min	Max	Unit	Conditions
Touch Sensor	Vin	3.0	2.6	[Volt]	
Power Voltage	VIII	3.0	3.6	[VOIL]	

4.3 Absolute Ratings of Environment

Item	Symbol	Min	Max	Unit	Conditions			
Operating Temperature	TOP	0	+50	[°C]	Note 4			
Operation Humidity	HOP	5	95	[%RH]	Note 4			
Storage Temperature	TST	-20	+60	[°C]	Note 4			
Storage Humidity	HST	5	95	[%RH]	Note 4			

Note 1: At Ta (25°C)

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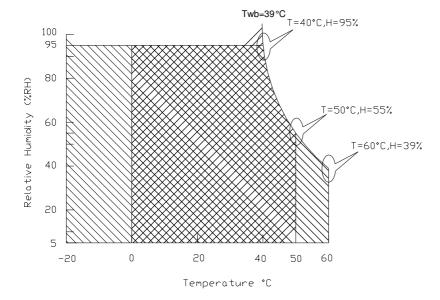


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Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



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5. Electrical Characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

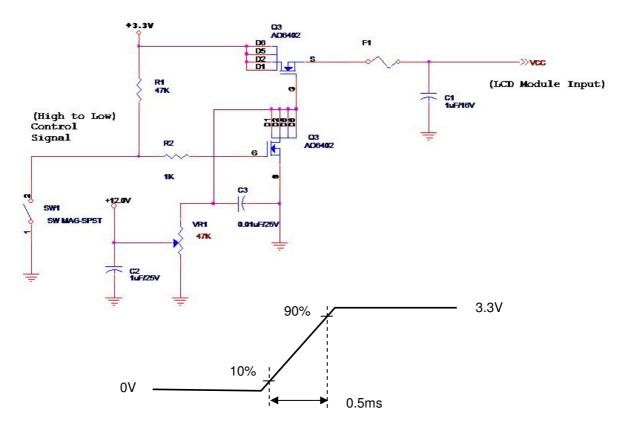
Input power specifications are as follows;

The power specification are measured under 25°C and frame frenquency under 60Hz

Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	-	0.9	[Watt]	Note 1
IDD	IDD Current	-	-	333	[mA]	Note 1
lRush	Inrush Current	-	-	2000	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1: Maximum Measurement Condition: White Pattern at 3.3V driving voltage. (P_{max}=V_{3.3} x I_{white})

Note 2: Measure Condition



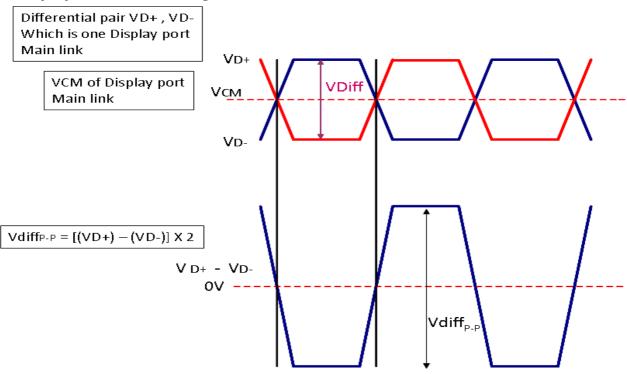
Vin rising time

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5.1.2 Signal Electrical Characteristics

Signal electrical characteristics are as follows;

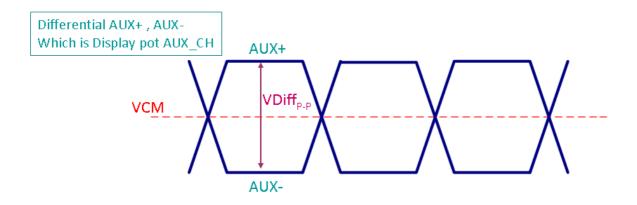
Display Port main link signal:



	Display port main link				
		Min	Тур	Max	unit
VCM	RX input DC Common Mode Voltage		GND		V
VDiff _{P-P}	Peak-to-peak Voltage at a receiving Device	100		1320	mV

Follow as VESA display port standard V1.1a

Display Port AUX_CH signal:





	Display port AUX_CH				
		Min	Тур	Max	unit
VCM	AUX DC Common Mode Voltage		GND/0.1 5		V
VDiff _{P-P}	AUX Peak-to-peak Voltage at a receiving Device	400	600	800	٧

Follow as VESA display port standard V1.1a.

Display Port VHPD signal:

	Display port VнРD				
		Min	Тур	Max	unit
VHPD	HPD Voltage	0	2.5	2.5	V

Follow as VESA display port standard V1.1a.



5.2.1 LED characteristics

Parameter	Symbol	Min	Тур	Max	Units	Condition
Backlight Power						
Consumption	PLED	-	2.2	2.5	[Watt]	(Ta=25℃), Note 1
LED Life-Time	N/A	15,000		_	Hour	(Ta=25℃), Note 2
	IN/A	13,000	-	-		I _F =20 mA

Note 1: Calculator value for reference P_{LED} = VF (Normal Distribution) * IF (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
LED Power Supply	VLED (Note 1)	6.0 (Note 2)	12.0	21.0	[Volt]	
LED Enable Input High Level	VLED EN	2.5	ı	5.5	[Volt]	
LED Enable Input Low Level	VLLD_LIN	-	1	0.8	[Volt]	Define as
PWM Logic Input High Level		2.5	-	5.5	[Volt]	Connector Interface
PWM Logic Input Low Level	VPWM_EN	-	-	0.8	[Volt]	(Ta=25°C)
PWM Input Frequency	FPWM	200	1K	10K	Hz	
PWM Duty Ratio	Duty	1 (Note 3)		100	%	

Note 1: Recommend system pull up/down resistor no bigger than 10kohm

Note 2: measured in panel VIN



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Note 3 : If the PWM duty ratio(min) is set between 5% to 1%, the PWM input frequency should be set below 1KHz.

The brightness-duty characteristic might not be able to keep in it's linearity if the dimming control is operated in 1% to 5% range.

5.3 Touch Sensor Power Consumption

Items	Symbol	Sp	ecification	ons	Unit	Notes	
Romo	Cymbol	Min.	Тур.	Max.	Orint	140103	
Touch Panel Power Supply	VDD	-	-	3.6	V		

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6. Signal Interface Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

		1									13	366	5
1st Line	R	G	В	R	G	В		R	G	В	R	G	В
												,	
					•				•			•	
							•		•			•	
							•						
		'			ı		,		1			ı	
768th Line	R	G	В	R	G	В		R	G	В	R	G	В

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6.3 Integration Interface Requirement

6.3.1 Connector Description

Physical interface is described as for the connector on module.

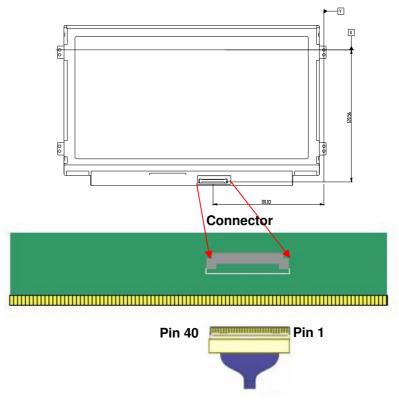
These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	STM or Compatible
Type / Part Number	MSAK24025P40 or Compatible
Mating Housing/Part Number	PK24025P40 or Compatible

6.3.2 Pin Assignment (with Touch Sensor Pin Assignment)

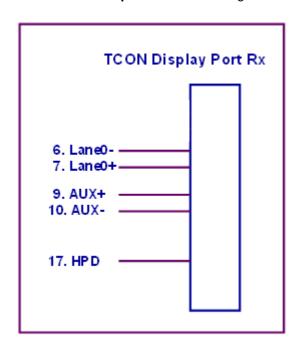
PIN NO	Symbol	Function
1	DCR EN	DCR enable function
2	H_GND	High Speed Ground
3	NC	No connect
4	NC	No connect
5	H GND	High Speed Ground
6	Lane0 N	Comp Signal Link Lane 0
7	Lane0 P	True Signal Link Lane 0
8	H GND	High Speed Ground
9	AUX CH P	True Signal Auxiliary Ch.
10	AUX_CH_N	Comp Signal Auxiliary Ch.
11	H GND	High Speed Ground
12	LCD VCC	LCD logic and driver power
13	LCD_VCC	LCD logic and driver power
14	LCD_Self_Test	LCD Panel Self Test Enable
15	LCD_GND	LCD logic and driver ground
16	LCD_GND	LCD logic and driver ground
17	HPD	HPD signal pin
18	BL_GND	Backlight ground
19	BL_GND	Backlight ground
20	BL_GND	Backlight ground
21	BL_GND	Backlight ground
22	BL_Enable	Backlight On / Off
23	BL_PWM_DIM	System PWM signal Input
24	NC	No connect
25	NC	No connect
26	NC	No connect
27	BL_PWR	Backlight power
28	BL_PWR	Backlight power
29	BL_PWR	Backlight power
30	CM_EN	CM enable function
31	TP_D-	USB Data- for Touch
32	TP_D+	USB Data+ for Touch
33	GND	Ground-Shield
34	VTSP	Touch panel power supply (3.3V)
35	VTSP	Touch panel power supply (3.3V)
36	NC/TP_EN (10pin CNT)	No Connection
	NC (8pin CNT)	(Reserve for Touch function enable)
37	TP_CLK	I2C Clock for Touch
38	TP_Data	I2C Data for Touch
39	INT	Interrupt for Touch
40	RST	Reset for Touch





Note1: Start from right side.

Note2: Input signals shall be low or High-impedance state when VDD is off. Internal circuit of eDP inputs are as following.





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6.4 Interface Timing

6.4.1 Timing Characteristics

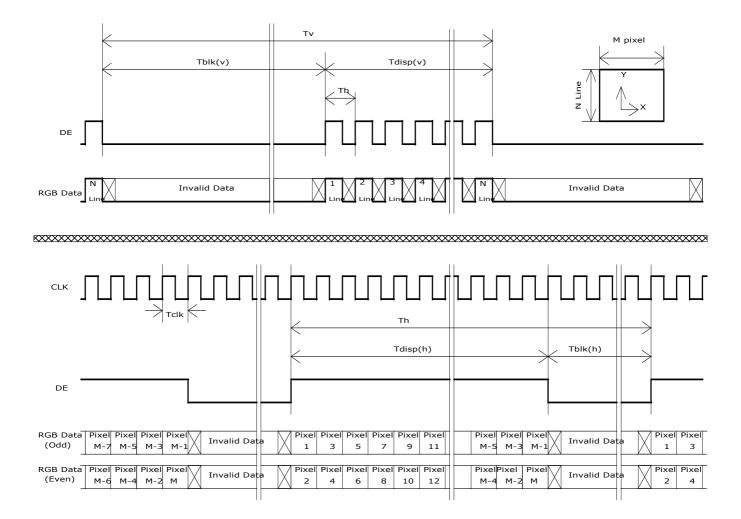
Basically, interface timings should match the 1366x768 /60Hz manufacturing guide line timing.

Parar	neter	Symbol	Min.	Тур.	Max.	Unit
Frame	e Rate	-	-	60	-	Hz
Clock frequency		1/ T _{Clock}	66.9	72	80	MHz
	Period	T _V	788	824	768+A	
Vertical	Active	T _{VD}		T_Line		
Section	Blanking	T _{VB}	20	56	Α	
	Period	T _H	1416	1456	1366+B	
Horizontal	Active	T _{HD}		1366		T _{Clock}
Section	Blanking	T _{HB}	50	90	В	

Note: 1. DE mode only

2. The maximum clock frequency = (1366+B)*(768+A)*60 < 80MHz

6.4.2 Timing diagram



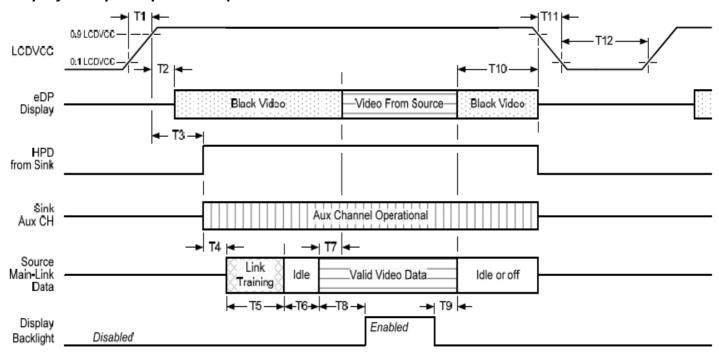


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6.4 Power ON/OFF Sequence

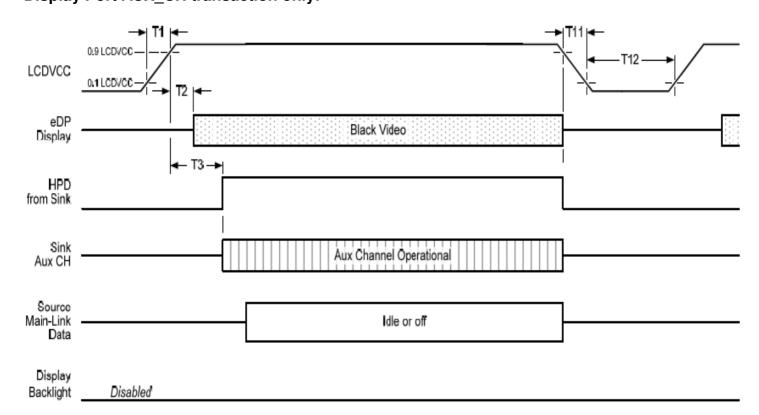
Power on/off sequence is as follows. Interface signals and LED on/off sequence are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off

Display Port panel power sequence:



Display port interface power up/down sequence, normal system operation

Display Port AUX CH transaction only:



Display port interface power up/down sequence, AUX_CH transaction only



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Display Port panel power sequence timing parameter:

Timing	Departution	Donal Inc	Limits			Notes	
parameter	Description	Reqd. by	Min.	Тур.	Max.	Notes	
T1	power rail rise time, 10% to 90%	source	0.5ms		10ms		
Т2	delay from LCDVDD to black video generation	sink	0ms		200ms	prevents display noise until valid video data is received from the source	
Т3	delay from LCDVDD to HPD high	sink	0ms		200ms	sink AUX_CH must be operational upon HPD high.	
Т4	delay from HPD high to link training initialization	source				allows for source to read link capability and initialize.	
Т5	link training duration	source				dependant on source link to read training protocol.	
Т6	link idle	source				Min accounts for required BS-Idle pattern. Max allows for source frame synchronization.	
Т7	delay from valid video data from source to video on display	sink	0ms		50ms	max allows sink validate video data and timing.	
Т8	delay from valid video data from source to backlight enable	source				source must assure display video is stable.	
Т9	delay from backlight disable to end of valid video data	source				source must assure backlight is no longer illuminated.	
T10	delay from end of valid video data from source to power off	source	0ms		500ms		
T11	power rail fall time, 905 to 10%	source			10ms		
T12	power off time	source	500ms				

Note1: The sink must include the ability to generate black video autonomously. The sink must automatically enable black video under the following conditions:

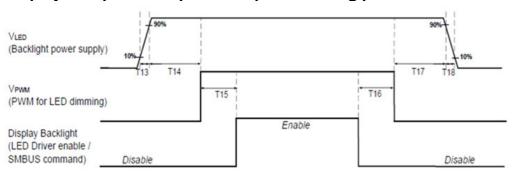
- -upon LCDVDD power on (with in T2 max)-when the "Novideostream_Flag" (VB-ID Bit 3) is received from the source (at the end of T9).
- -when no main link data, or invalid video data, is received from the source. Black video must be displayed within 64ms (typ) from the start of either condition. Video data can be deemed invalid based on MSA and timing information, for example.

Note 2: The sink may implement the ability to disable the black video function, as described in Note 1, above, for system development and debugging purpose.

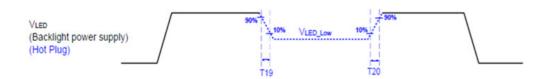
Note 3: The sink must support AUX_CH polling by the source immediately following LCDVDD power on without causing damage to the sink device (the source can re-try if the sink is not ready). The sink must be able to respond to an AUX_CH transaction with the time specified within T3 max.



Display Port panel B/L power sequence timing parameter:



Note: When the adapter is hot plugged, the backlight power supply sequence is shown as below.



	Min (ms)	Max (ms)		
T13	0.5	10		
T14	10	-		
T15	10	_		
T16	10	-		
T17	10	-		
T18	0.5	10		
T19	1*	-		
T20	1*			

Seamless change: T19/T20 = 5xT_{PWM}*

^{*}T_{PWM}= 1/PWM Frequency



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7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

Test method: Non-Operation

Acceleration: 1.5 G

• Frequency: 10 - 500Hz Random

Sweep: 30 Minutes each Axis (X, Y, Z)

7.2 Shock Test

Test Spec:

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 240h	
High Temperature Operation	Ta= 60℃, Dry, 240h	
Low Temperature Operation	Ta=0℃, 240h	
High Temperature Storage	Ta= 60℃, 240h	
Low Temperature Storage	Ta= -20℃, 240h	
Thermal Shock Test	Ta=-20°C (30min) ~60°C (30min), 20cycles condition.	
ESD	Contact : ±8 KV Air : ±15 KV	Note 1

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

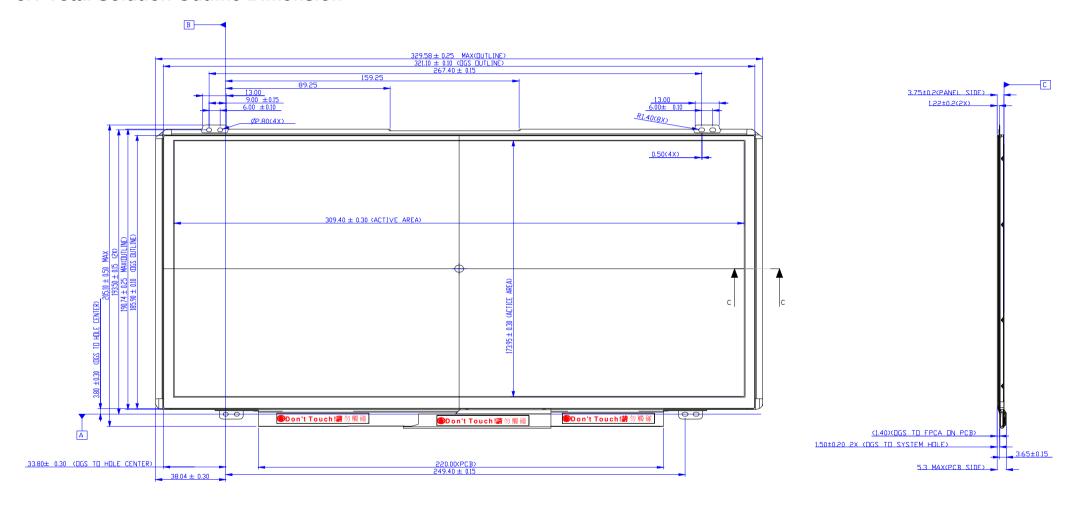
. Self-recoverable. No hardware failures.

Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%

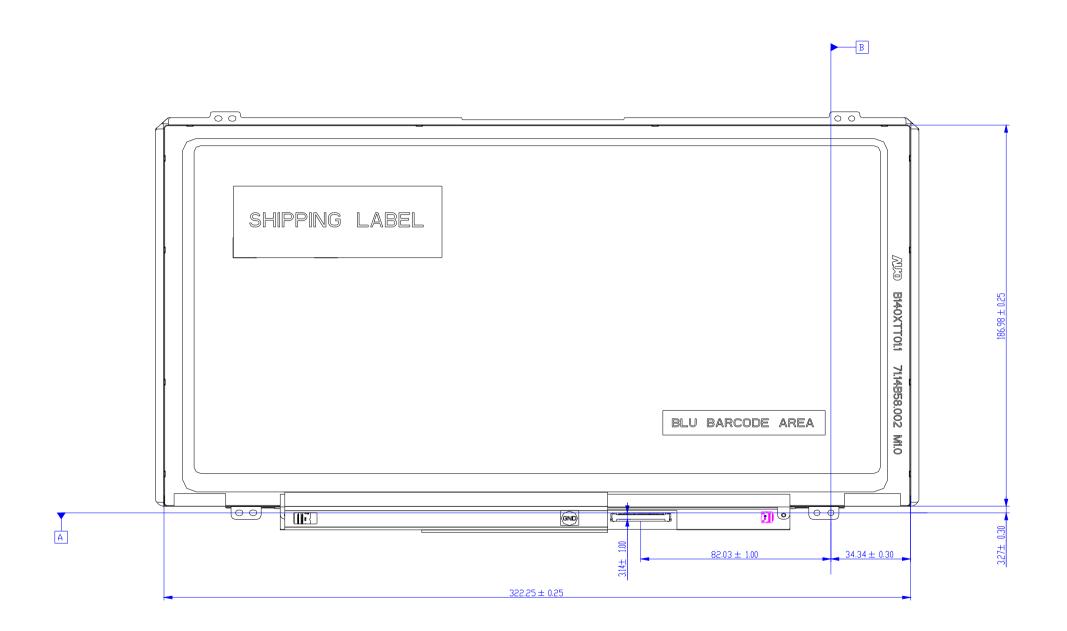
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8. Mechanical Characteristics

8.1 Total Solution Outline Dimension





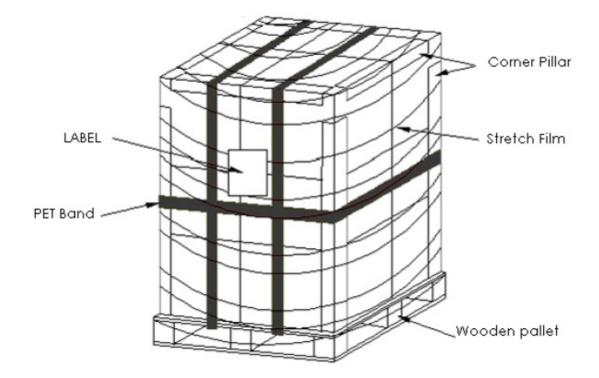


9. Shipping and Package

9.1 Shipping Label Format



9.2 Shipping Package of Palletizing Sequence



10. Appendix: EDID Description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
80	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	3C	00111100	60	
0B	hex, LSB first	11	00010001	17	
0C	32-bit ser #	00	00000000	0	
0D		00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	00	00000000	0	
11	Year of manufacture	16	00010110	22	
12	EDID Structure Ver.	01	00000001	1	
13	EDID revision #	04	00000100	4	
14	Video input def. (digital I/P, non-TMDS, CRGB)	95	10010101	149	
15	Max H image size (rounded to cm)	1F	00011111	31	
16	Max V image size (rounded to cm)	11	00010001	17	
17	Display Gamma (=(gamma*100)-100)	78	01111000	120	
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	02	0000010	2	
19	Red/green low bits (Lower 2:2:2:2 bits)	BB	10111011	187	
1A	Blue/white low bits (Lower 2:2:2:2 bits)	F5	11110101	245	
1B	Red x (Upper 8 bits)	94	10010100	148	
1C	Red y/ highER 8 bits	55	01010101	85	
1D	Green x	54	01010100	84	
1E	Green y	90	10010000	144	
1F	Blue x	27	00100111	39	
20	Blue y	23	00100011	35	
21	White x	50	01010000	80	
22	White y	54	01010100	84	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	0000001	1	
27		01	0000001	1	
28	Standard timing #2	01	0000001	1	
29		01	0000001	1	
2A	Standard timing #3	01	00000001	1	

2B		01	00000001	1	
2C	Standard timing #4	01	00000001	1	
2D	Standard timing #4	01	00000001	1	
2E	Standard timing #5	01	00000001	1	
2F	otandara anning no	01	00000001	1	
30	Standard timing #6	01	00000001	1	
31		01	0000001	1	
32	Standard timing #7	01	0000001	1	
33		01	0000001	1	
34	Standard timing #8	01	0000001	1	
35		01	0000001	1	
36	Pixel Clock/10000 LSB	CE	11001110	206	
37	Pixel Clock/10000 USB	1D	00011101	29	
38	Horz active Lower 8bits	56	01010110	86	
39	Horz blanking Lower 8bits	D2	11010010	210	
3A	HorzAct:HorzBlnk Upper 4:4 bits	50	01010000	80	
3B	Vertical Active Lower 8bits	00	00000000	0	
3C	Vertical Blanking Lower 8bits	26	00100110	38	
3D	Vert Act : Vertical Blanking (upper 4:4 bit)	30	00110000	48	
3E	HorzSync. Offset	10	00010000	16	
3F	HorzSync.Width	10	00010000	16	
40	VertSync.Offset : VertSync.Width	3E	00111110	62	
41	Horz‖ Sync Offset/Width Upper 2bits	00	00000000	0	
42	Horizontal Image Size Lower 8bits	35	00110101	53	
43	Vertical Image Size Lower 8bits	AD	10101101	173	
44	Horizontal & Vertical Image Size (upper 4:4 bits) Horizontal Border (zero for internal LCD)	10	00010000	16	
45	Vertical Border (zero for internal LCD)	00	00000000	0	
46 47	Signal (non-intr, norm, no stero, sep sync, neg pol)	18	00000000	0 24	
48	Detailed timing/monitor	00	00011000	0	
49	descriptor #2	00	00000000	0	
4A	descriptor #2	00	00000000	0	
4B		0F	00001111	15	
4C		00	00000000	0	
4D		00	00000000	0	
4E		00	00000000	0	
4F		00	00000000	0	
50		00	00000000	0	
51		00	00000000	0	
52		00	00000000	0	
53		00	00000000	0	
54		00	00000000	0	
55		00	00000000	0	
56		00	00000000	0	
57		00	00000000	0	
58		00	00000000	0	
59		20	00100000	32	

5A	Detailed timing/monitor	00	00000000	0	
5B	descriptor #3	00	00000000	0	
5C		00	00000000	0	
5D		FE	11111110	254	
5E		00	00000000	0	
5F	Manufacture	41	01000001	65	Α
60	Manufacture	55	01010101	85	U
61	Manufacture	4F	01001111	79	0
62		0A	00001010	10	
63		20	00100000	32	
64		20	00100000	32	
65		20	00100000	32	
66		20	00100000	32	
67		20	00100000	32	
68		20	00100000	32	
69		20	00100000	32	
6A		20	00100000	32	
6B		20	00100000	32	
6C	Detailed timing/monitor	00	00000000	0	
6D	descriptor #4	00	00000000	0	
6E		00	00000000	0	
6F		FE	11111110	254	
70		00	00000000	0	
71	Manufacture P/N	42	01000010	66	В
72	Manufacture P/N	31	00110001	49	1
73	Manufacture P/N	34	00110100	52	4
74	Manufacture P/N	30	00110000	48	0
75	Manufacture P/N	58	01011000	88	X
76	Manufacture P/N	54	01010100	84	Т
77	Manufacture P/N	54	01010100	84	Т
78	Manufacture P/N	30	00110000	48	0
79	Manufacture P/N	31	00110001	49	1
7 A	Manufacture P/N	2E	00101110	46	
7B	Manufacture P/N	31	00110001	49	1
7C		20	00100000	32	
7D		0A	00001010	10	
7E	Extension Flag	00	00000000	0	
7F	Checksum	13	00010011	19	